

General Description

OCP8020 is a complete constant-current and constant-voltage linear charger for single cell lithium-ion and Lithium-Polymer batteries. Its SOT23-5L Package and low external component count make OCP8020 ideally suited for portable applications. Furthermore, the OCP8020 is specifically designed to work within USB power specification. At the same time, OCP8020 can also be used in the standalone lithium-ion and Lithium-polymer battery charger.

No external sense resistor is needed, and no blocking diode is required due to the internal MOSFET architecture. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be programmed externally with a single resistor. The OCP8020 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

When the input supply (wall adapter or USB supply) is removed, the OCP8020 automatically enters a low current stage, dropping the battery drain current to less than $2\mu A$. The OCP8020 can be put into shutdown mode, reducing the supply current to $25\mu A$.

Other features include charge current monitor, undervoltage lockout, automatic recharge and a status pin to indicate termination and the presence of an input voltage.

Features

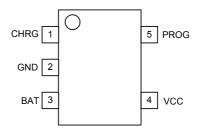
- Programmable Charge Current Up to 800mA
- No MOSFET, Sense Resistor or Blocking Diode Required
- Constant-Current/Constant-Voltage Operation with Thermal Protection to Maximize Charge Rate without Risk of Overheating
- Charges Single Cell Li-Ion Batteries Directly from USB Port
- Press 4.2V Charge Voltage with ± 1% Accuracy
- 25μA. Supply Current in Shutdown
- 2.9V Trickle Charge Threshold
- Available Without Trickle Charge
- Soft-Start Limits Inrush Current
- Available in 5-pin SOT23 Package

Applications

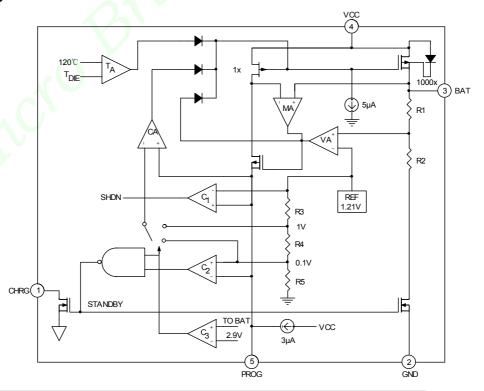
- Cellular Telephones, PDA's, MP3 Players
- Charging Docks and Cradles
- Bluetooth Applications

■ Pin Configuration

(Top View)



Block Diagram





■ Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Rating	Unit
Input Supply Voltage	V_{CC}	10	V
PROG Voltage	V_{PROG}	V _{CC} +0.3	V
BAT Voltage	BAT Voltage V _{BAT}		V
CHRG Voltage	V_{CHRG}	10	V
BAT Short-Circuit Duration		Continuous	
BAT Pin Current	l _{BAT}	800	mA
PROG Pin Current	I _{PROG}	800	μA
Maximum Junction Temperature	TJ	125	${\mathbb C}$
Storage Temperature	T_S	-65 to +125	$^{\circ}$
Lead Temperature(Soldering, 10sec)		300	${\mathbb C}$

Note 1: Exceeding the absolute maximum rating may damage the device.

■ Operating Rating (Note 2)

Parameter	Symbol	Rating	Unit
Input Supply Voltage	V_{IN}	-0.3 to 10	V
Operating Temperature Range	T _{OP}	-40 to +85	$^{\circ}$

Note 2: The device is not guaranteed to function outside its operating rating.

■ Electrical Characteristics

(V_{IN} =5V, V_{OUT} =1.8V, T_J =25°C, Unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{CC}	Input Supply Voltage	(),	4.25		6.5	V
		Charge Mode ^{(Note 3}), R _{PROG} =10K		190		μA
	L	Standby Mode(Charge Terminated)		85		μA
I _{CC}	Input Supply Current	Shutdown Mode (R _{PROG} Not Connected,		25		
		$V_{CC} < V_{BAT}$, or $V_{CC} < V_{UV}$)		25		μA
V _{FLOAT}	Regulated Output (Float) Voltage	0°C ≤T _J ≤85°C, I _{BAT} =40mA		4.2		V
		Current Mode , R _{PROG} =10K		110		mA
		Current Mode , R _{PROG} =2K		500		mA
I_{BAT}	BAT Pin Current	Standby Mode, V _{BAT} =4.2V		4		μA
unurur DateGhootd I I not		Shutdown Mode(R _{PROG} Not Connected)		±1		μΑ
WWW.DIMEARCHOLIKE		Sleep Mode, V _{CC} =-0V		±1		μΑ
I _{TRIKL}	Trickle Charge Current	$V_{BAT} < V_{TRIKL}, R_{PORG} = 10K$		12		mΑ
V_{TRIKL}	Trickle Charge Threshold Voltage	R _{PROG} =10K, V _{BAT} Rising		2.9		V
V _{UV}	V _{CC} Undervoltage Lockout Threshold	From V _{CC} Low to High		3.4		V
V _{UVHYS}	V _{CC} Undervoltage Lockout Hysteresis			170		mV
\/	Manual Shutdown	PROG Pin Rising		1.25		V
V_{MSD}	Threshold Voltage	PROG Pin Falling		1.2		V
V_{ASD}	V _{CC} -V _{BAT} Lockout	V _{CC} from Low to High		100		mV
V ASD	Threshold Voltage	V _{CC} from High to Low		30		mV
 	C/10 Termination	R _{PROG} =10K ^(Note 4)		0.1		mA/mA
I _{TERM}	Current Threshold	R _{PROG} =2K		0.1		mA/mA



■ Electrical Characteristics (Continued)

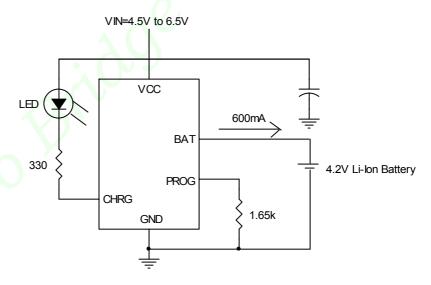
(V_{IN}=5V, V_{OUT}=1.8V, T_J =25 $^{\circ}$ C, Unless otherwise noted)

Symbol	Parameter	Conditions Mir		Тур.	Max.	Unit
V_{PROG}	PROG Pin Voltage	Current Mode, R _{PROG} =10K		1.03		V
I _{CHRG}	CHRG Pin Weak Pull Down Current	V _{CHRG} =5V	V _{CHRG} =5V			μΑ
V _{CHRG}	CHRG Pin Output Low Voltage	I _{CHRG} =5mA	I _{CHRG} =5mA			V
Δ V _{RECHRG}	Recharge Battery Threshold Voltage	V _{FLOAT} -V _{RECHRG}		100		mV
T _{LIM}	Thermal Protection Temperature			120		${\mathbb C}$
t _{ss}	Soft-Start Time	I _{BAT} =0 to 1000V/R _{PROG}		100		μs
t _{RECHRG}	Recharge Comparator Filter Time	V _{BAT} High to Low	2,	2		ms
t _{TERM}	Termination Comparator Filter Time	I _{BAT} Falling Below I _{CHG} /10		1000		μs
I _{PROG}	PROG Pin Pull-Up Current			1		μA

Note 3: Supply current includes PROG pin current (approximately 100µA) but does not include any current delivered to the battery through the BAT pin (approximately 100mA).

Note 4: I_{TERM} is expressed as a fraction of measured full charge current with indicated PROG resistor.

■ Application Circuit



600mA Single Cell Li-Ion Charger



Application Hints

Stability Considerations

The constant-voltage mode feedback loop is stable without an output capacitor provided a battery is connected to the charge output. With no battery present, an output capacitor is recommended to reduce ripple voltage. When using high value, low ESR ceramic capacitors, it is recommended to add a 1 resistor in series with the capacitor. No series resistor is needed if tantalum capacitors are used.

In constant-current mode, the PROG pin is in the feedback loop, not the battery. The constant-current mode stability is affected by the impedance at the PROG pin. With no additional capacitance on the PROG pin, the charger is stable with program resistor values as high as 20k. However, additional capacitance on this mode reduces the maximum allowed program resistor. The pole frequency at the PROG pin should be kept above 100kHz.

V_{CC} Bypass Capacitor

Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charge input to a live power source. Adding a 1.5 resistor in series with a ceramic capacitor will minimize start-up voltage transients.

Power Dissipation

The conditions that cause the OCP8020 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET-this is calculated to be approximately:

$$P_D = (V_{CC} - V_{BAT}) * I_{BAT}$$

The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

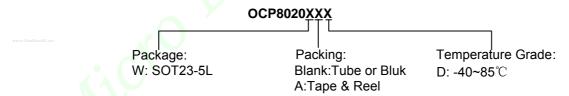
$$T_A=120^{\circ}C-P_D^{\circ}\theta_{JA}$$

 $T_A=120^{\circ}C-(V_{CC}-V_{BAT})^*I_{BAT}^{*}\theta_{JA}$

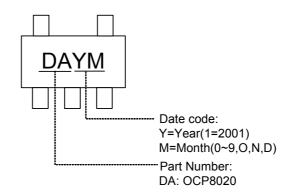
Thermal Considerations

Because of the small size of the thin SOT23 package, it is very important to use a good thermal PC board layout to maximize the available charge current. The thermal path for the heat generated by the IC is from the die to the cooper lead frame, through the package leads, (especially the ground lead) to the PC board copper. The PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Other heat sources on the board, not related to the charger, must also be considered when affect overall temperature rise and the maximum charge current.

Ordering Information

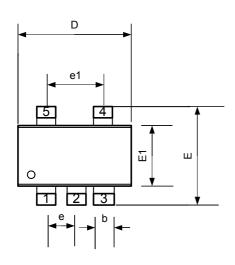


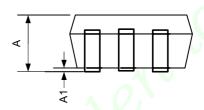
Marking Information

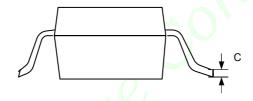




■ Package Information







Symbol	Dimensions In Millimeters Dimension		Dimensions	ns In Inches	
Syllibol	Min.	Min. Max. Min.	Min.	Max.	
Α	0.90	1.30	0.036	0.051	
A1		0.15		0.006	
b	0.35	0.50	0.014	0.020	
www.DataSheer Caet	0.09	0.20	0.0036	0.008	
D	2.80	3.05	0.112	0.120	
E	2.60	3.00	0.102	0.118	
E1	1.50	1.75	0.060	0.070	
е	0.95 Bsc.		0.038 Bsc.		
e1	1.90 Bsc.		0.076 Bsc.		